

## **Excellent Integrated System Limited**

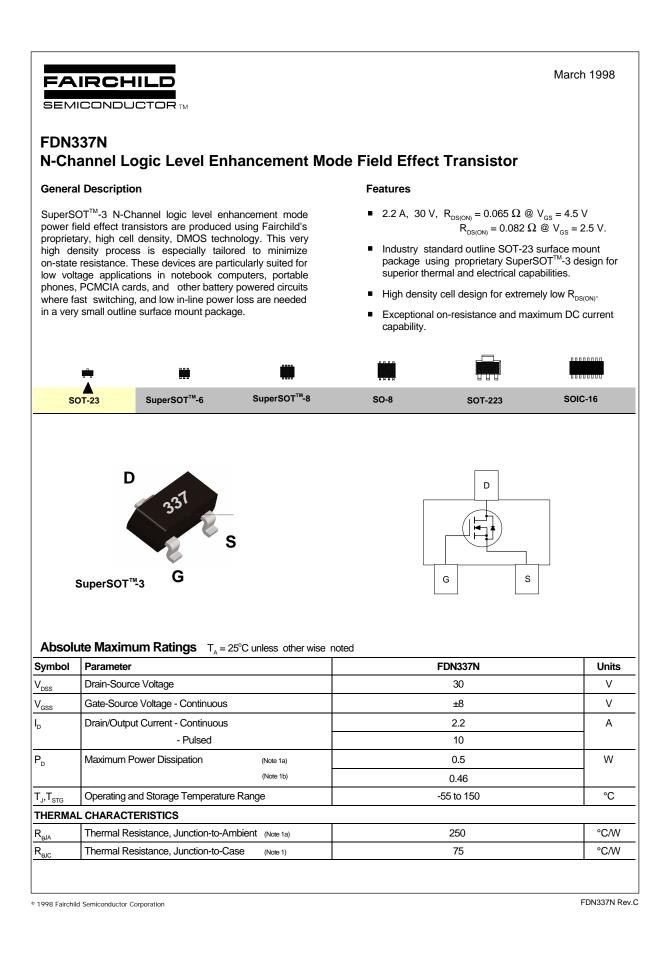
Stocking Distributor

Click to view price, real time Inventory, Delivery & Lifecycle Information:

Fairchild Semiconductor FDN337N

For any questions, you can email us directly: <u>sales@integrated-circuit.com</u>







Symbol	Parameter	Conditions	Min	Тур	Max	Units
OFF CHAR	ACTERISTICS					
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	$V_{GS} = 0 V, I_{D} = 250 \mu A$	30			V
$\Delta BV_{DSS} / \Delta T_{J}$	Breakdown Voltage Temp. Coefficient	$I_{D}$ = 250 µA, Referenced to 25 °C		41		mV/°C
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	$V_{DS} = 24 V, V_{GS} = 0 V$			1	μA
		T <sub>J</sub> = 55°C			10	μA
GSSF	Gate - Body Leakage, Forward	$V_{GS} = 8 V, V_{DS} = 0 V$			100	nA
GSSR	Gate - Body Leakage, Reverse	$V_{GS} = -8 \text{ V}, V_{DS} = 0 \text{ V}$			-100	nA
	CTERISTICS (Note)					
V <sub>GS(th)</sub>	Gate Threshold Voltage	$V_{\rm DS} = V_{\rm GS}, \ I_{\rm D} = 250 \ \mu {\rm A}$	0.4	0.7	1	V
$\Delta V_{GS(th)} / \Delta T_J$	Gate Threshold Voltage Temp. Coefficient	$I_{D} = 250 \ \mu\text{A}$ , Referenced to 25 °C		-2.3		mV/°C
R <sub>DS(ON)</sub>	Static Drain-Source On-Resistance	$V_{GS} = 4.5 \text{ V}, I_{D} = 2.2 \text{ A}$		0.054	0.065	Ω
D3(ON)		T <sub>J</sub> =125°C		0.08	0.11	
		$V_{GS} = 2.5 \text{ V}, I_{D} = 2 \text{ A}$		0.07	0.082	
D(ON)	On-State Drain Current	$V_{GS} = 4.5 \text{ V}, V_{DS} = 5 \text{ V}$	10			А
9 <sub>FS</sub>	Forward Transconductance	$V_{DS} = 5 V, I_{D} = 2.2 A$		13		S
DYNAMIC C	HARACTERISTICS					
C <sub>iss</sub>	Input Capacitance	$V_{DS} = 10 V, V_{GS} = 0 V,$		300		pF
C <sub>oss</sub>	Output Capacitance	f = 1.0 MHz		145		pF
C <sub>rss</sub>	Reverse Transfer Capacitance			35		pF
SWITCHING	CHARACTERISTICS (Note)				-	-
t <sub>D(on)</sub>	Turn - On Delay Time	$V_{DD} = 5 V, I_{D} = 1 A,$		4	10	ns
t,	Turn - On Rise Time	$V_{GS} = 4.5 \text{ V}, \text{ R}_{GEN} = 6 \Omega$		10	18	ns
D(off)	Turn - Off Delay Time			17	28	ns
f	Turn - Off Fall Time			4	10	ns
Q <sub>g</sub>	Total Gate Charge	$V_{\rm DS} = 10 \text{ V}, \ \text{I}_{\rm D} = 2.2 \text{ A},$		7	9	nC
Q <sub>gs</sub>	Gate-Source Charge	$V_{GS} = 4.5 V$		1.1		nC
Q <sub>gd</sub>	Gate-Drain Charge			1.9		nC
DRAIN-SO	JRCE DIODE CHARACTERISTICS AND M	IAXIMUM RATINGS	-	T		
s	Maximum Continuous Drain-Source Diode Forward Current				0.42	A
V <sub>SD</sub>	Drain-Source Diode Forward Voltage	$V_{\rm GS} = 0 \ V, \ I_{\rm S} = 0.42 \ A \ ({\rm Note})$		0.65	1.2	V
Note:						

Scale 1 : 1 on letter size paper

2. Pulse Test: Pulse Width  $\leq$  300µs, Duty Cycle  $\leq$  2.0%.



i N

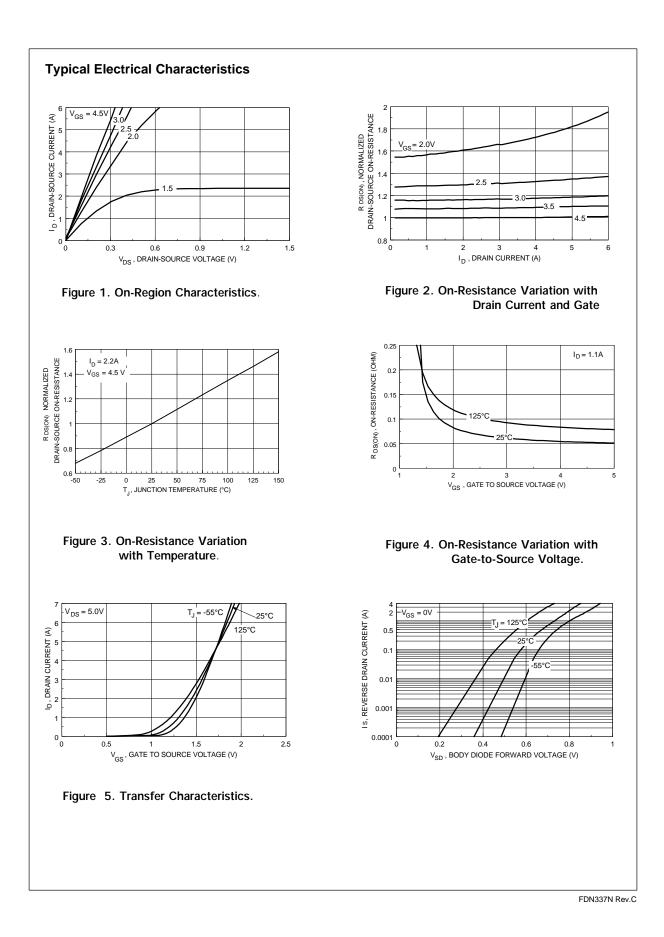
a. 250°C/W when mounted on 0.02 in<sup>2</sup> pad of 2oz Cu.

b. 270°C/W when mounted on a 0.001 in<sup>2</sup> pad of 2oz Cu.

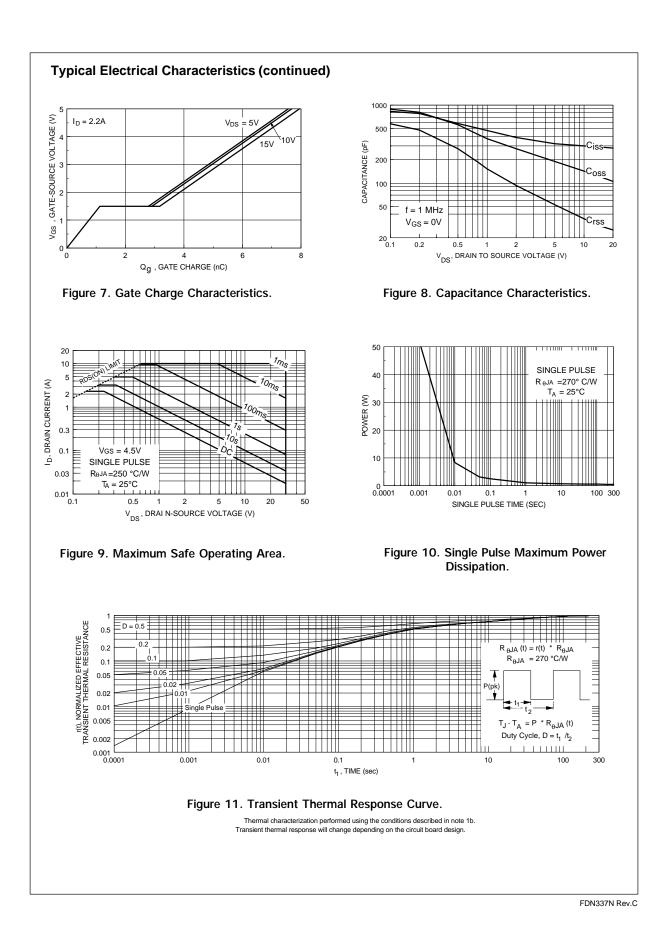
а

FDN337N Rev.C











Obsolete

TRADEMARKS	TRADEMARKS									
The following are registered and unregistered trademarks Fairchild Semiconductor owns or is authorized to use and is not intended to be an exhaustive list of all such trademarks.										
Bottomless $\mathbb{M}$ CoolFET $\mathbb{M}$ CROSSVOLT $\mathbb{M}$ DenseTrench $\mathbb{M}$ DOME $\mathbb{M}$ EcoSPARK $\mathbb{M}$ E2CMOS $\mathbb{M}$ EnSigna $\mathbb{M}$ FACT $\mathbb{M}$ FACT $\mathbb{M}$	FAST <sup>®</sup> FASTr <sup>™</sup> FRFET <sup>™</sup> GlobalOptoisolator <sup>™</sup> GTO <sup>™</sup> HiSeC <sup>™</sup> SOPLANAR <sup>™</sup> LittleFET <sup>™</sup> MicroFET <sup>™</sup> MicroPak <sup>™</sup> MICROWIRE <sup>™</sup>	OPTOLOGIC <sup>™</sup> OPTOPLANAR <sup>™</sup> PACMAN <sup>™</sup> POP <sup>™</sup> Power247 <sup>™</sup> PowerTrench <sup>®</sup> QFET <sup>™</sup> QS <sup>™</sup> QT Optoelectronics <sup>™</sup> Quiet Series <sup>™</sup> SILENT SWITCHER <sup>®</sup>	UHC™							
STAR*POWER is used under DISCLAIMER	license									
FAIRCHILD SEMICONDUCTOR RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION OR DESIGN. FAIRCHILD DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT RIGHTS, NOR THE RIGHTS OF OTHERS. IFE SUPPORT POLICY FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF FAIRCHILD SEMICONDUCTOR CORPORATION. As used herein: 1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, or (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in significant injury to the user. PRODUCT STATUS DEFINITIONS										
Definition of Terms	Durdant Otatur		<b>B</b> (f) (f)							
Datasheet Identification	Product Status		Definition							
Advance Information	Formative or In Design	product developm	This datasheet contains the design specifications for product development. Specifications may change in any manner without notice.							
Preliminary	First Production	supplementary dat Fairchild Semicone	This datasheet contains preliminary data, and supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice in order to improve design.							
No Identification Needed	Full Production	This datasheet co	ontains final specifications. Fairchild							

Not In Production

Semiconductor reserves the right to make changes at any time without notice in order to improve design.

This datasheet contains specifications on a product that has been discontinued by Fairchild semiconductor. The datasheet is printed for reference information only.